# 74HC4053; 74HCT4053

Triple 2-channel analog multiplexer/demultiplexer

Rev. 12 — 9 February 2023 Product data sheet

### 1. General description

The 74HC4053; 74HCT4053 is a triple single-pole double-throw analog switch (3x SPDT) suitable for use in analog or digital 2:1 multiplexer/demultiplexer applications. Each switch features a digital select input (Sn), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ). A digital enable input ( $\overline{E}$ ) is common to all switches. When  $\overline{E}$  is HIGH, the switches are turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

#### 2. Features and benefits

- Wide analog input voltage range from -5 V to +5 V
- CMOS low power dissipation
- · High noise immunity
- Latch-up performance exceeds 100 mA per JESD78 Class II Level B
- Complies with JEDEC standard:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Low ON resistance:
  - 80 Ω (typical) at V<sub>CC</sub> V<sub>EE</sub> = 4.5 V
  - 70 Ω (typical) at V<sub>CC</sub> V<sub>EE</sub> = 6.0 V
  - 60 Ω (typical) at V<sub>CC</sub> V<sub>EE</sub> = 9.0 V
- Logic level translation: to enable 5 V logic to communicate with ±5 V analog signals
- · Typical 'break before make' built-in
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

# 3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

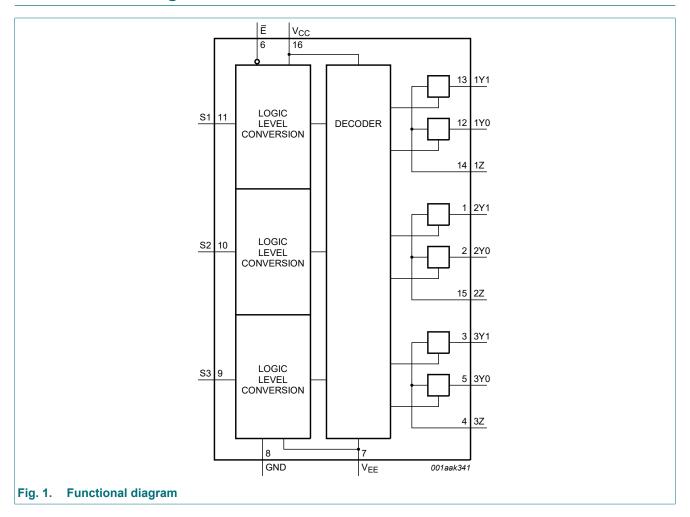


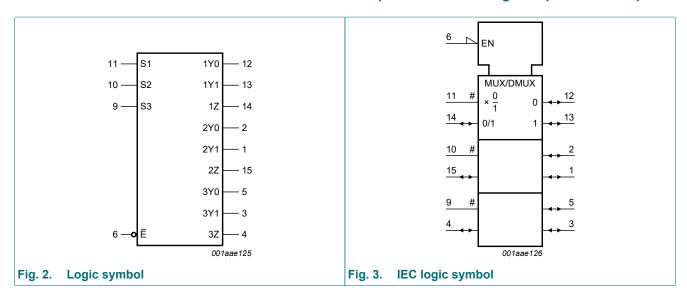
# 4. Ordering information

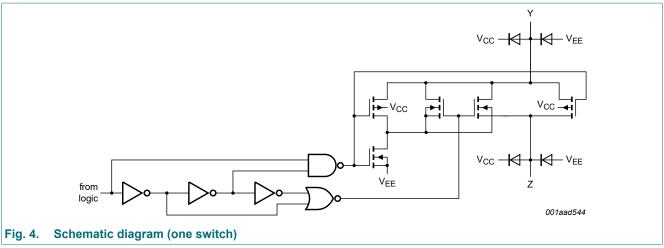
**Table 1. Ordering information** 

Type number	Package			
	Temperature range	Name	Description	Version
74HC4053D 74HCT4053D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HC4053PW 74HCT4053PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74HC4053BQ 74HCT4053BQ	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1
74HC4053BZ 74HCT4053BZ	-40 °C to +125 °C	DHXQFN16	plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 16 terminals; 0.4 mm pitch; body 2 mm × 2.4 mm × 0.48 mm	SOT8016-1

# 5. Functional diagram

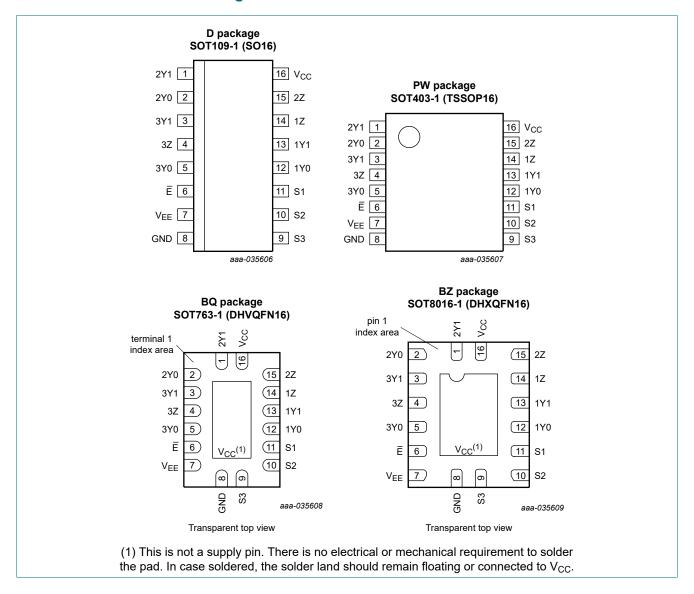






### 6. Pinning information

#### 6.1. Pinning



### 6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
E	6	enable input (active LOW)
V <sub>EE</sub>	7	supply voltage
GND	8	ground supply voltage
S1, S2, S3	11, 10, 9	select input
1Y0, 2Y0, 3Y0	12, 2, 5	independent input or output
1Y1, 2Y1, 3Y1	13, 1, 3	independent input or output
1Z, 2Z, 3Z	14, 15, 4	common output or input
V <sub>CC</sub>	16	supply voltage

# 7. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$ 

Inputs	Inputs		
E	Sn		
L	L	nY0 to nZ	
L	Н	nY1 to nZ	
Н	X	switches off	

### 8. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 \text{ V}$  (ground).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage		[1]	-0.5	+11.0	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I <sub>SK</sub>	switch clamping current	$V_{SW}$ < -0.5 V or $V_{SW}$ > $V_{CC}$ + 0.5 V		-	±20	mA
I <sub>SW</sub>	switch current	$-0.5 \text{ V} < \text{V}_{\text{SW}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I <sub>EE</sub>	supply current			-	±20	mA
I <sub>CC</sub>	supply current			-	50	mA
I <sub>GND</sub>	ground current			-	-50	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
Р	power dissipation	per switch		-	100	mW
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C				
		SOT109-1 (SO16)	[2]	-	500	mW
		SOT403-1 (TSSOP16)	[3]	-	500	mW
		SOT763-1 (DHVQFN16)	[4]	-	500	mW
		SOT8016-1 (DHXQFN16)		-	250	mW

<sup>[1]</sup> To avoid drawing  $V_{CC}$  current out of terminal nZ, when switch current flows into terminals nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no  $V_{CC}$  current will flow out of terminals nYn, and in this case there is no limit for the voltage drop across the switch, but the voltages at nYn and nZ may not exceed  $V_{CC}$  or  $V_{EE}$ .

# 9. Recommended operating conditions

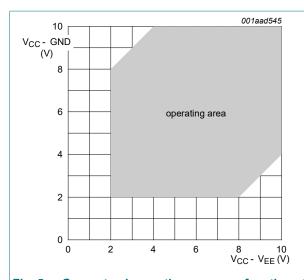
Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	7	74HC405	3	7	4HCT405	53	Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage	see <u>Fig. 5</u> and <u>Fig. 6</u>							
		V <sub>CC</sub> - GND	2.0	5.0	10.0	4.5	5.0	5.5	V
		V <sub>CC</sub> - V <sub>EE</sub>	2.0	5.0	10.0	2.0	5.0	10.0	V
VI	input voltage		GND	-	V <sub>CC</sub>	GND	-	V <sub>CC</sub>	V
V <sub>SW</sub>	switch voltage		V <sub>EE</sub>	-	V <sub>CC</sub>	V <sub>EE</sub>	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
	rate	V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V
		V <sub>CC</sub> = 10.0 V	-	-	31	-	-	-	ns/V

<sup>[2]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C.

<sup>[3]</sup> For SOT403-1 (TSSOP16) package: Ptot derates linearly with 8.5 mW/K above 91 °C.

<sup>[4]</sup> For SOT763-1 (DHVQFN16) package: P<sub>tot</sub> derates linearly with 11.2 mW/K above 106 °C.





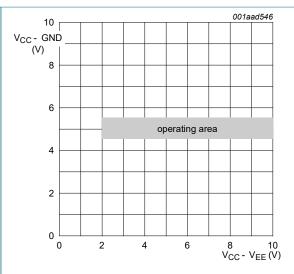


Fig. 6. Guaranteed operating area as a function of the supply voltages for 74HCT4053

#### 10. Static characteristics

#### Table 6. R<sub>ON</sub> resistance per switch for 74HC4053 and 74HCT4053

 $V_I = V_{IH}$  or  $V_{IL}$ ; for test circuit see Fig. 7.

 $V_{is}$  is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

 $V_{os}$  is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

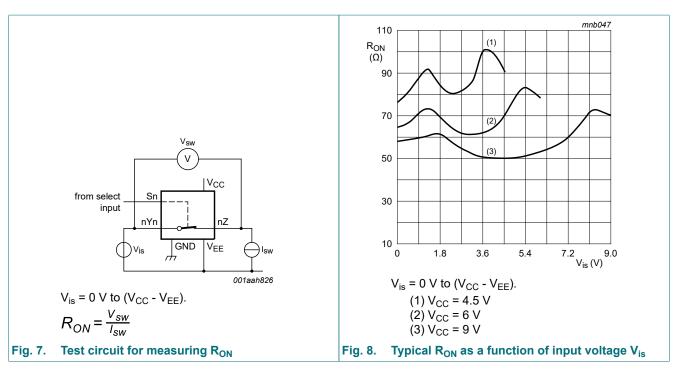
For 74HC4053:  $V_{CC}$  - GND or  $V_{CC}$  -  $V_{EE}$  = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

For 74HCT4053:  $V_{CC}$  - GND = 4.5 V and 5.5 V,  $V_{CC}$  -  $V_{EE}$  = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = 25	°C				1		
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_{is} = V_{CC}$ to $V_{EE}$					
		$V_{CC}$ = 2.0 V; $V_{EE}$ = 0 V; $I_{SW}$ = 100 $\mu$ A	[1]	-	-	-	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = 0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	100	180	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	90	160	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	70	130	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	$V_{is} = V_{EE}$					
		$V_{CC}$ = 2.0 V; $V_{EE}$ = 0 V; $I_{SW}$ = 100 $\mu$ A	[1]	-	150	-	Ω
		$V_{CC} = 4.5 \text{ V}; V_{EE} = 0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	80	140	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	70	120	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	60	105	Ω
		V <sub>is</sub> = V <sub>CC</sub>					
		$V_{CC}$ = 2.0 V; $V_{EE}$ = 0 V; $I_{SW}$ = 100 $\mu$ A	[1]	-	150	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	90	160	Ω
		$V_{CC} = 6.0 \text{ V}; V_{EE} = 0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	80	140	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	65	120	Ω
ΔR <sub>ON</sub>	ON resistance mismatch	$V_{is} = V_{CC}$ to $V_{EE}$					
	between channels	V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	9	-	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V		-	8	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	6	-	Ω

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +85 °C						
R <sub>ON(peak)</sub>	ON resistance (peak)	V <sub>is</sub> = V <sub>CC</sub> to V <sub>EE</sub>					
		$V_{CC} = 2.0 \text{ V}; V_{EE} = 0 \text{ V}; I_{SW} = 100 \mu\text{A}$	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	225	Ω
		$V_{CC} = 6.0 \text{ V}; V_{EE} = 0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	-	200	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	-	165	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	V <sub>is</sub> = V <sub>EE</sub>					
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 100 μA	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	175	Ω
		$V_{CC} = 6.0 \text{ V}; V_{EE} = 0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	-	150	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	-	130	Ω
		$V_{is} = V_{CC}$					
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 100 μA	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	200	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	175	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	-	150	Ω
T <sub>amb</sub> = -4	0 °C to +125 °C						
R <sub>ON(peak)</sub>	ON resistance (peak)	V <sub>is</sub> = V <sub>CC</sub> to V <sub>EE</sub>					
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 100 μA	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	270	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	240	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	-	195	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	V <sub>is</sub> = V <sub>EE</sub>					
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 100 μA	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	210	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	180	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	-	160	Ω
		$V_{is} = V_{CC}$					
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 100 μA	[1]	-	-	-	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	240	Ω
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V; I <sub>SW</sub> = 1000 μA		-	-	210	Ω
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V; I <sub>SW</sub> = 1000 μA		-	-	180	Ω

<sup>[1]</sup> When supply voltages (V<sub>CC</sub> - V<sub>EE</sub>) near 2.0 V the analog switch ON resistance becomes extremely non-linear. When using a supply of 2 V, it is recommended to use these devices only for transmitting digital signals.



#### Table 7. Static characteristics for 74HC4053

Voltages are referenced to GND (ground = 0 V).

 $V_{is}$  is the input voltage at pins nYn or nZ, whichever is assigned as an input.

Vos is the output voltage at pins nZ or nYn, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C			'	1	
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	V
	voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	V
		V <sub>CC</sub> = 9.0 V	6.3	4.7	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	V
	voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	V
		V <sub>CC</sub> = 9.0 V	-	4.3	2.7	V
I <sub>I</sub>	input leakage	V <sub>EE</sub> = 0 V; V <sub>I</sub> = V <sub>CC</sub> or GND				
	current	V <sub>CC</sub> = 6.0 V	-	-	±0.1	μA
		V <sub>CC</sub> = 10.0 V	-	-	±0.2	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 9$				
		per channel	-	-	±0.1	μΑ
		all channels	-	-	±0.1	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 10$	-	-	±0.1	μΑ
I <sub>CC</sub>	supply current	$V_{EE} = 0 \text{ V}; V_{I} = V_{CC} \text{ or GND}; V_{is} = V_{EE} \text{ or } V_{CC};$ $V_{os} = V_{CC} \text{ or } V_{EE}$				
		V <sub>CC</sub> = 6.0 V	-	-	8.0	μA
		V <sub>CC</sub> = 10.0 V	-	-	16.0	μA
Cı	input capacitance		-	3.5	-	pF

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>sw</sub>	switch capacitance	independent pins nYn	-	5	-	pF
		common pins nZ	-	8	-	pF
T <sub>amb</sub> = -4	40 °C to +85 °C		,			
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
	voltage	V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
		V <sub>CC</sub> = 9.0 V	6.3	-	- K - N - N - N - N - N - N - N - N - N - N	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
	voltage	V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
		V <sub>CC</sub> = 9.0 V	-	-	2.7	V
l <sub>l</sub>	input leakage	V <sub>EE</sub> = 0 V; V <sub>I</sub> = V <sub>CC</sub> or GND				
	current	V <sub>CC</sub> = 6.0 V	-	-	±1.0	μA
		V <sub>CC</sub> = 10.0 V	-	-	±2.0	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; Fig. 9$				
		per channel	-	-	±1.0	μA
		all channels	-	-	±1.0	μΑ μΑ μΑ μΑ μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see Fig. } 10$	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_{EE}$ = 0 V; $V_{I}$ = $V_{CC}$ or GND; $V_{is}$ = $V_{EE}$ or $V_{CC}$ ; $V_{os}$ = $V_{CC}$ or $V_{EE}$				
		V <sub>CC</sub> = 6.0 V	-	-	±1.0 μ ±1.0 μ 80.0 μ 160.0 μ	μA
		V <sub>CC</sub> = 10.0 V	-	-		μA
T <sub>amb</sub> = -4	40 °C to +125 °C		,			
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
	voltage	V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
		V <sub>CC</sub> = 9.0 V	6.3	-	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
	voltage	V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
		V <sub>CC</sub> = 9.0 V	-	-	2.7	V
l <sub>l</sub>	input leakage	V <sub>EE</sub> = 0 V; V <sub>I</sub> = V <sub>CC</sub> or GND				
	current	V <sub>CC</sub> = 6.0 V	-	-	±1.0 μ/μ ±1.0 μ/μ  ±1.0 μ/μ  80.0 μ/μ  160.0 μ/μ  - V  - V  - V  0.5 V  1.35 V  1.8 V  2.7 V	μA
		V <sub>CC</sub> = 10.0 V	-	-	±2.0	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see Fig. 9}$				
		per channel	-	-	±1.0	μA
		all channels	-	-	±1.0 μ ±1.0 μ ±1.0 μ ±1.0 μ 80.0 μ 160.0 μ - ν - ν - ν 0.5 ν 1.35 ν 1.8 ν 2.7 ν ±1.0 μ ±2.0 μ ±1.0 μ	μA
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 10$	-	-	±1.0	μΑ

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CC</sub>	supply current	$V_{EE}$ = 0 V; $V_{I}$ = $V_{CC}$ or GND; $V_{is}$ = $V_{EE}$ or $V_{CC}$ ; $V_{os}$ = $V_{CC}$ or $V_{EE}$				
		V <sub>CC</sub> = 6.0 V	-	-	160.0	μΑ
		V <sub>CC</sub> = 10.0 V	-	-	320.0	μΑ

#### Table 8. Static characteristics for 74HCT4053

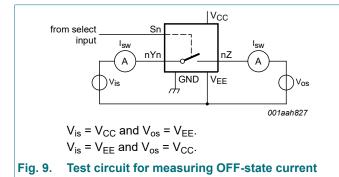
Voltages are referenced to GND (ground = 0 V).

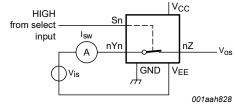
 $V_{is}$  is the input voltage at pins nYn or nZ, whichever is assigned as an input.

 $V_{os}$  is the output voltage at pins nZ or nYn, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ ; $V_{EE} = 0 \text{ V}$	-	-	±0.1	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 9$				
		per channel	-	-	±0.1	μA
		all channels	-	-	±0.1	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 10$	-	-	±0.1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $V_{is} = V_{EE}$ or $V_{CC}$ ; $V_{os} = V_{CC}$ or $V_{EE}$				
		V <sub>CC</sub> = 5.5 V; V <sub>EE</sub> = 0 V	-	-	8.0	μΑ
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = -5.0 V	-	-	16.0	μΑ
ΔI <sub>CC</sub>	additional supply current	per input; $V_I = V_{CC}$ - 2.1 V; other inputs at $V_{CC}$ or GND; $V_{CC}$ = 4.5 V to 5.5 V; $V_{EE}$ = 0 V	-	50	180	μA
Cı	input capacitance		-	3.5	-	pF
C <sub>sw</sub>	switch capacitance	independent pins nYn	-	5	-	pF
		common pins nZ	-	8	-	pF
T <sub>amb</sub> = -	40 °C to +85 °C			'	1	·
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ ; $V_{EE} = 0 \text{ V}$	-	-	±1.0	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 9$				
		per channel	-	-	±1.0	μΑ
		all channels	-	-	±1.0	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 10$	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $V_{is} = V_{EE}$ or $V_{CC}$ ; $V_{os} = V_{CC}$ or $V_{EE}$				
		V <sub>CC</sub> = 5.5 V; V <sub>EE</sub> = 0 V	-	-	80.0	μΑ
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = -5.0 V	-	-	160.0	μA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
ΔI <sub>CC</sub>	additional supply current	per input; $V_I = V_{CC}$ - 2.1 V; other inputs at $V_{CC}$ or GND; $V_{CC}$ = 4.5 V to 5.5 V; $V_{EE}$ = 0 V	-	-	225	μΑ
T <sub>amb</sub> = -4	40 °C to +125 °C					·
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ ; $V_{EE} = 0 \text{ V}$	-	-	±1.0	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 9$				
		per channel	-	-	±1.0	μA
		all channels	-	-	±1.0	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; V_{EE} = 0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL};$ $ V_{SW}  = V_{CC} - V_{EE}; \text{ see } Fig. 10$	-	-	±1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $V_{is} = V_{EE}$ or $V_{CC}$ ; $V_{os} = V_{CC}$ or $V_{EE}$				
		V <sub>CC</sub> = 5.5 V; V <sub>EE</sub> = 0 V	-	-	160.0	μΑ
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = -5.0 V	-	-	320.0	μΑ
ΔI <sub>CC</sub>	additional supply current	per input; $V_I = V_{CC} - 2.1 \text{ V}$ ; other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $V_{EE} = 0 \text{ V}$	-	-	245	μΑ





 $V_{is} = V_{CC}$  and  $V_{os} =$  open-circuit.  $V_{is} = V_{EE}$  and  $V_{os} =$  open-circuit.

Fig. 10. Test circuit for measuring ON-state current

# 11. Dynamic characteristics

#### Table 9. Dynamic characteristics for 74HC4053

GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF; for test circuit see Fig. 13.

V<sub>is</sub> is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

 $V_{os}$  is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
T <sub>amb</sub> = 2	T <sub>amb</sub> = 25 °C								
t <sub>pd</sub>	propagation delay	$V_{is}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 11</u> [1]							
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	15	60	ns			
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	5	12	ns			
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	4	10	ns			
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	4	8	ns			

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>on</sub>	turn-on time	E to V <sub>os</sub> ; R <sub>L</sub> = ∞ Ω; see <u>Fig. 12</u> [2]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	60	220	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	20	44	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF	-	17	-	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	16	37	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	15	31	ns
		Sn to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 12</u> [2]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	75	220	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	25	44	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF	-	21	-	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	20	37	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	15	31	ns
t <sub>off</sub>	turn-off time	$\overline{E}$ to V <sub>os</sub> ; R <sub>L</sub> = 1 k $\Omega$ ; see <u>Fig. 12</u> [3]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	63	210	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	21	42	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF	-	18	-	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	17	36	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	15	29	ns
		Sn to $V_{os}$ ; $R_L = 1 k\Omega$ ; see Fig. 12 [3]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	60	210	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	20	42	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF	-	17	-	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	16	36	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	15	29	ns
C <sub>PD</sub>	power dissipation capacitance	per switch; $V_I = GND$ to $V_{CC}$ [4]	-	36	-	pF
T <sub>amb</sub> = -4	40 °C to +85 °C					
t <sub>pd</sub>	propagation delay	$V_{is}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 11</u> [1]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	75	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	15	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	13	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	10	ns
t <sub>on</sub>	turn-on time	$\overline{E}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see Fig. 12 [2]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	275	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	55	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	47	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	39	ns
		Sn to $V_{os}$ ; $R_L = \infty \Omega$ ; see Fig. 12 [2]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	275	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	55	ns
ı		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	47	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	39	ns

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>off</sub>	turn-off time	$\overline{E}$ to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see $\underline{Fig. 12}$ [3]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	265	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	53	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	45	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	36	ns
		Sn to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see Fig. 12 [3]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	265	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	53	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	45	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	36	ns
T <sub>amb</sub> = -	40 °C to +125 °C					
t <sub>pd</sub>	propagation delay	$V_{is}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 11</u> [1]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	90	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	18	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	15	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	12	ns
t <sub>on</sub>	turn-on time	$\overline{E}$ to $V_{os}; R_{L} = \infty \ \Omega; see \ \underline{Fig.  12}$				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	330	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	66	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	56	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	47	ns
		Sn to $V_{os}$ ; $R_L = \infty \Omega$ ; see Fig. 12 [2]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	330	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	66	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	56	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	47	ns
t <sub>off</sub>	turn-off time	$\overline{E}$ to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see $\underline{Fig. 12}$ [3]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	315	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	63	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	54	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	44	ns
		Sn to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see Fig. 12 [3]				
		V <sub>CC</sub> = 2.0 V; V <sub>EE</sub> = 0 V	-	-	315	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	63	ns
		V <sub>CC</sub> = 6.0 V; V <sub>EE</sub> = 0 V	-	-	54	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	44	ns
	*			*	*	

 $t_{\text{pd}}$  is the same as  $t_{\text{PHL}}$  and  $t_{\text{PLH}}$ .

<sup>[2]</sup> t<sub>on</sub> is the same as t<sub>PZH</sub> and t<sub>PZL</sub>.
[3] t<sub>off</sub> is the same as t<sub>PHZ</sub> and t<sub>PLZ</sub>.
[4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma \{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

N = number of inputs switching;  $\Sigma\{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$  = sum of outputs;

 $C_L$  = output load capacitance in pF;  $C_{sw}$  = switch capacitance in pF;

 $V_{CC}$  = supply voltage in V.

#### Table 10. Dynamic characteristics for 74HCT4053

GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF; for test circuit see Fig. 13.

 $V_{is}$  is the input voltage at a nYn or nZ terminal, whichever is assigned as an input.

 $V_{os}$  is the output voltage at a nYn or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = 2	25 °C						
t <sub>pd</sub>	propagation delay	$V_{is}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 11</u>	[1]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	5	12	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	4	8	ns
t <sub>on</sub>	turn-on time	$\overline{E}$ to V <sub>os</sub> ; R <sub>L</sub> = 1 k $\Omega$ ; see <u>Fig. 12</u>	[2]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	27	48	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF		-	23	-	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	16	34	ns
		Sn to $V_{os}$ ; $R_L = 1 k\Omega$ ; see Fig. 12	[2]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	25	48	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF		-	21	-	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	16	34	ns
t <sub>off</sub>	turn-off time	$\overline{E}$ to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see $\underline{Fig. 12}$	[3]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	24	44	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF		-	20	-	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	15	31	ns
		Sn to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see Fig. 12	[3]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	22	44	ns
		V <sub>CC</sub> = 5.0 V; V <sub>EE</sub> = 0 V; C <sub>L</sub> = 15 pF		-	19	-	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	15	31	ns
C <sub>PD</sub>	power dissipation capacitance	per switch; V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	[4]	-	36	-	pF
T <sub>amb</sub> = -	40 °C to +85 °C						<b>'</b>
t <sub>pd</sub>	propagation delay	$V_{is}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 11</u>	[1]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	-	15	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	-	10	ns
t <sub>on</sub>	turn-on time	$\overline{E}$ to V <sub>os</sub> ; R <sub>L</sub> = 1 k $\Omega$ ; see <u>Fig. 12</u>	[2]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	-	60	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	-	43	ns
		Sn to $V_{os}$ ; $R_L = 1 k\Omega$ ; see Fig. 12	[2]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	-	60	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	-	43	ns
t <sub>off</sub>	turn-off time	$\overline{E}$ to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see $\underline{Fig. 12}$	[3]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	-	55	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V		-	-	39	ns
		Sn to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see Fig. 12	[3]				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V		-	-	55	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V			_	39	ns

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -	40 °C to +125 °C			-1	1	
t <sub>pd</sub> propagation delay		$V_{is}$ to $V_{os}$ ; $R_L = \infty \Omega$ ; see <u>Fig. 11</u> [1				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	18	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	12	ns
t <sub>on</sub>	turn-on time	$\overline{E}$ to V <sub>os</sub> ; R <sub>L</sub> = 1 k $\Omega$ ; see <u>Fig. 12</u> [2				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	72	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	51	ns
		Sn to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see Fig. 12	]			
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	72	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	51	ns
t <sub>off</sub>	turn-off time	$\overline{E}$ to V <sub>os</sub> ; R <sub>L</sub> = 1 k $\Omega$ ; see <u>Fig. 12</u> [3				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	66	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	47	ns
		Sn to $V_{os}$ ; $R_L = 1 \text{ k}\Omega$ ; see Fig. 12	]			
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	-	66	ns
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	-	47	ns

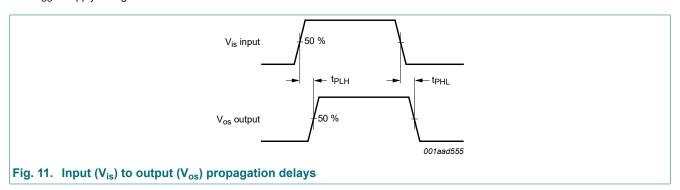
- $t_{\text{pd}}$  is the same as  $t_{\text{PHL}}$  and  $t_{\text{PLH}}$ .
- ton is the same as t<sub>PZH and</sub> t<sub>PZL</sub>.
- $t_{\text{off}}$  is the same as  $t_{\text{PHZ}}$  and  $t_{\text{PLZ}}$ .
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma \{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$  where:

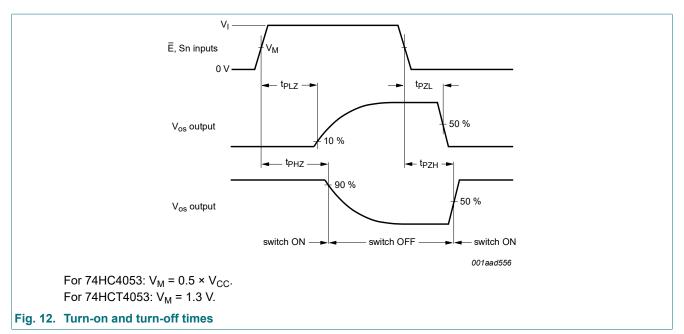
 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

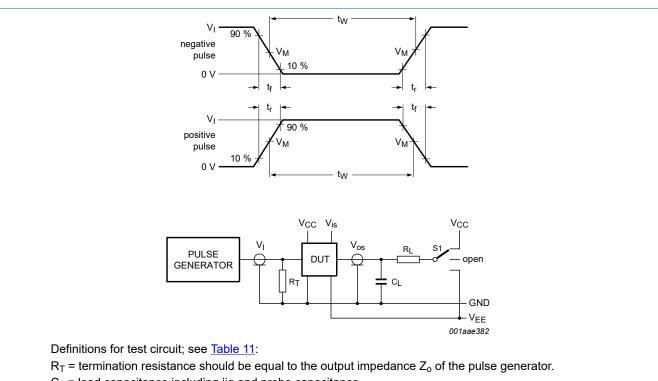
N = number of inputs switching;  $\Sigma\{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$  = sum of outputs;

 $C_L$  = output load capacitance in pF;  $C_{sw}$  = switch capacitance in pF;

V<sub>CC</sub> = supply voltage in V.







 $C_L$  = load capacitance including jig and probe capacitance.

 $R_{I}$  = load resistance.

S1 = Test selection switch.

Fig. 13. Test circuit for measuring AC performance

Table 11. Test data

Test	Input			Load	Load		
	V <sub>I</sub> [1]	V <sub>is</sub>	t <sub>r</sub> , t <sub>f</sub>	t <sub>r</sub> , t <sub>f</sub>		R <sub>L</sub>	
			at f <sub>max</sub>	other [2]			
t <sub>PHL</sub> , t <sub>PLH</sub>	V <sub>CC</sub>	pulse	< 2 ns	6 ns	50 pF	1 kΩ	open
t <sub>PZH</sub> , t <sub>PHZ</sub>	V <sub>CC</sub>	V <sub>CC</sub>	< 2 ns	6 ns	50 pF	1 kΩ	V <sub>EE</sub>
t <sub>PZL</sub> , t <sub>PLZ</sub>	V <sub>CC</sub>	V <sub>EE</sub>	< 2 ns	6 ns	50 pF	1 kΩ	V <sub>CC</sub>

<sup>[1]</sup> For 74HCT4053:  $V_1 = 3 V$ 

### 11.1. Additional dynamic characteristics

#### Table 12. Additional dynamic characteristics

Recommended conditions and typical values; GND = 0 V;  $T_{amb}$  = 25 °C;  $C_L$  = 50 pF.  $V_{is}$  is the input voltage at pins nYn or nZ, whichever is assigned as an input.

 $V_{os}$  is the output voltage at pins nYn or nZ, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
d <sub>sin</sub>	sine-wave distortion	$f_i$ = 1 kHz; $R_L$ = 10 kΩ; see Fig. 14				
		V <sub>is</sub> = 4.0 V (p-p); V <sub>CC</sub> = 2.25 V; V <sub>EE</sub> = -2.25 V	-	0.04	-	%
		$V_{is} = 8.0 \text{ V (p-p)}; V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	0.02	-	%
		$f_i$ = 10 kHz; $R_L$ = 10 kΩ; see Fig. 14				
		$V_{is} = 4.0 \text{ V (p-p)}; V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$	-	0.12	-	%
		$V_{is} = 8.0 \text{ V (p-p)}; V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$	-	0.06	-	%
$\alpha_{\text{iso}}$	isolation (OFF-state)	R <sub>L</sub> = 600 Ω; f <sub>i</sub> = 1 MHz; see <u>Fig. 15</u>				
		$V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$ [1]	-	-50	-	dB
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$ [1]	-	-50	-	dB
Xtalk	crosstalk	between two switches/multiplexers; $R_L$ = 600 $\Omega$ ; $f_i$ = 1 MHz; see Fig. 16				
		$V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$ [1]	-	-60	-	dB
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$ [1]	-	-60	-	dB
V <sub>ct</sub>	crosstalk voltage	peak-to-peak value; between control and any switch; $R_L = 600 \ \Omega$ ; $f_i = 1 \ \text{MHz}$ ; $E$ or Sn square wave between $V_{CC}$ and GND; $t_r = t_f = 6 \ \text{ns}$ ; see Fig. 17				
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = 0 V	-	110	-	mV
		V <sub>CC</sub> = 4.5 V; V <sub>EE</sub> = -4.5 V	-	220	-	mV
f <sub>(-3dB)</sub>	-3 dB frequency	$R_L$ = 50 Ω; see <u>Fig. 18</u>				
	response	$V_{CC} = 2.25 \text{ V}; V_{EE} = -2.25 \text{ V}$ [2]	-	160	-	MHz
		$V_{CC} = 4.5 \text{ V}; V_{EE} = -4.5 \text{ V}$ [2]	-	170	-	MHz

<sup>[1]</sup> Adjust input voltage  $V_{is}$  to 0 dBm level (0 dBm = 1 mW into 600  $\Omega$ ).

<sup>[2]</sup>  $t_r = t_f = 6$  ns; when measuring  $f_{max}$ , there is no constraint to  $t_r$  and  $t_f$  with 50 % duty factor.

<sup>[2]</sup> Adjust input voltage  $V_{is}$  to 0 dBm level at  $V_{os}$  for 1 MHz (0 dBm = 1 mW into 50 Ω).

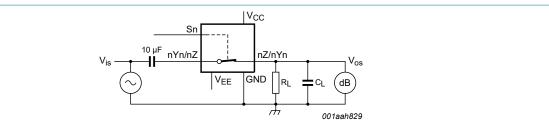
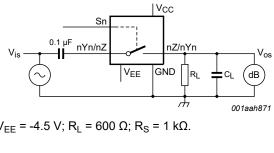


Fig. 14. Test circuit for measuring sine-wave distortion



 $V_{CC}$  = 4.5 V; GND = 0 V;  $V_{EE}$  = -4.5 V;  $R_L$  = 600  $\Omega;$   $R_S$  = 1 k $\Omega.$ a.Test circuit

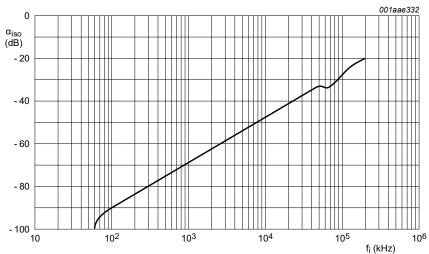
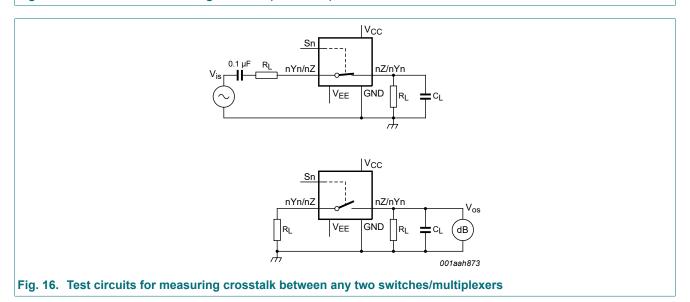


Fig. 15. Test circuit for measuring isolation (OFF-state)

b.Isolation (OFF-state) as a function of frequency



74HC\_HCT4053

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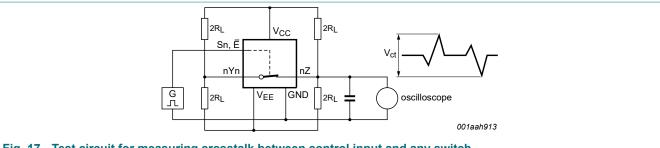
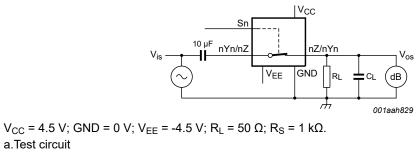
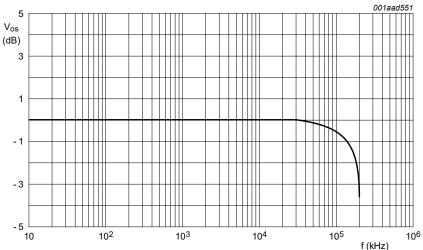


Fig. 17. Test circuit for measuring crosstalk between control input and any switch





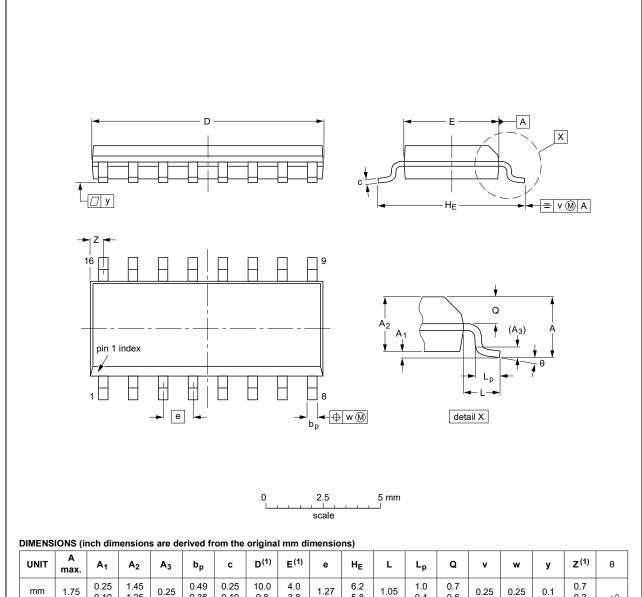
b. Typical frequency response

Fig. 18. Test circuit for frequency response

# 12. Package outline



SOT109-1



UN	IT ma		A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mr	n 1.1	75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inch	es 0.0	069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

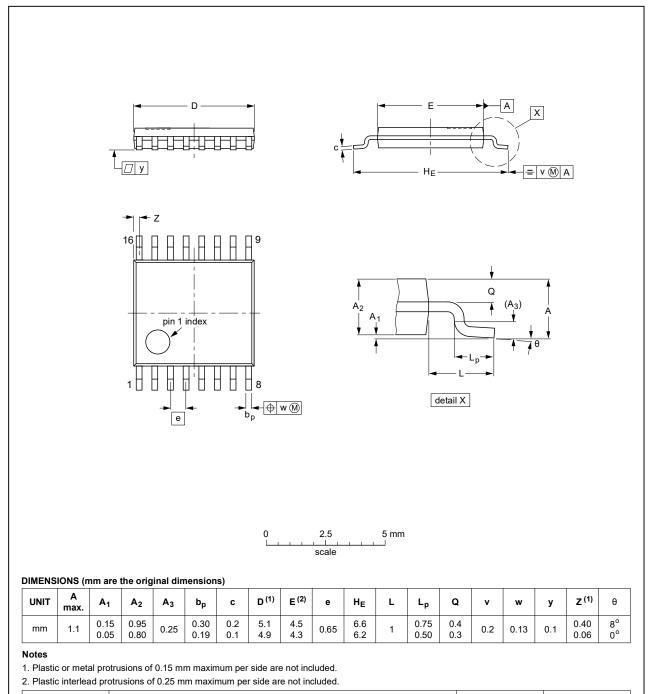
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012			<del>99-12-27</del> 03-02-19

Fig. 19. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT403-1		MO-153			<del>99-12-27</del> 03-02-18

Fig. 20. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

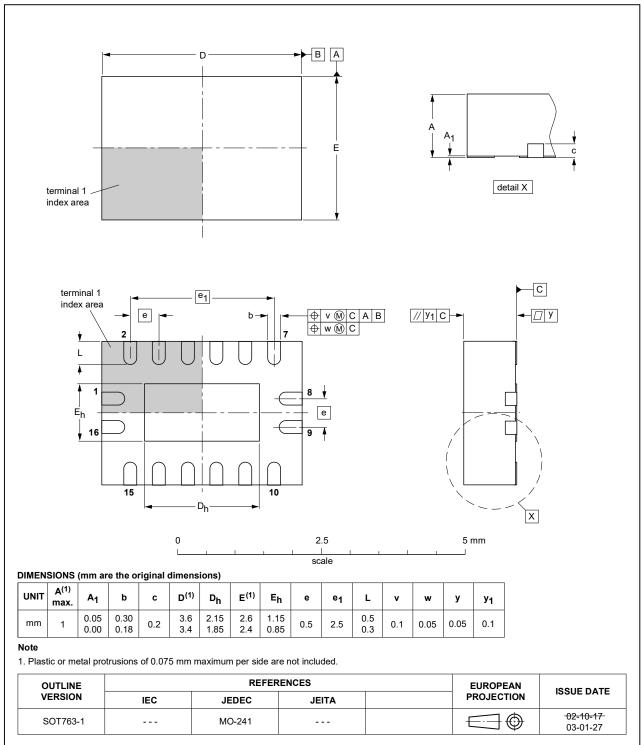


Fig. 21. Package outline SOT763-1 (DHVQFN16)

DHXQFN16: plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 16 terminals; 0.4 mm pitch; body 2 mm x 2.4 mm x 0.48 mm SOT8016-1 □ z C 2x D Е pin 1 index area seating plane detail X \_ z C 2x ⊕ w M C A B // y<sub>1</sub> C pin 1 index area e (12x) pin1 I.D. 16 (16x) 10 u M C A B v M C (16x) 2 mm scale Dimensions (mm are the original dimensions) Unit  $\mathsf{A}_3$ D  $D_1$ Е E<sub>1</sub> е L  $A_1$ b k u z У У1 0.48 0.05 0.23 1.40 1.00 0.35 max 0.15 2.4 1.35 2.0 nom 0.45 0.02 0.18 0.95 0.4 0.30 0.1 0.05 0.1 0.05 0.05 0.05 (typ) min 0.42 0.00 0.13 1.30 0.90 0.2 0.25 sot8016-1\_po References Outline European Issue date projection version IEC **JEDEC** JEITA

Fig. 22. Package outline SOT8016-1 (DHXQFN16)

20-09-18

20-09-22

 $\bigcirc$ 

SOT8016-1

### 13. Abbreviations

#### **Table 13. Abbreviations**

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

# 14. Revision history

#### Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4053 v.12	20230209	Product data sheet	-	74HC_HCT4053 v.11
Modifications:	Added type	numbers 74HC4053BZ ar	nd 74HCT4053BZ	(SOT8016-1/DHXQFN16).
74HC_HCT4053 v.11	20210909	Product data sheet	-	74HC_HCT4053 v.10
Modifications:	<ul><li>Type number</li><li>Section 2 up</li></ul>	er 74HC4053DB (SOT338- pdated.	-1/SSOP16) remo	ved.
74HC_HCT4053 v.10	20200305	Product data sheet	-	74HC_HCT4053 v.9
Modifications:	guidelines of Legal texts Type number	of this data sheet has beer of Nexperia. have been adapted to the er 74HCT4053DB (SOT33 rating values for P <sub>tot</sub> total p	new company nar 8-1) removed.	ne where appropriate.
74HC_HCT4053 v.9	20160210	Product data sheet	-	74HC_HCT4053 v.8
Modifications:	Type number	ers 74HC4053N and 74HC	T4053N (SOT38-	4) removed.
74HC_HCT4053 v.8	20120719	Product data sheet	-	74HC_HCT4053 v.7
Modifications:	CDM added	to features.	•	
74HC_HCT4053 v.7	20111213	Product data sheet	-	74HC_HCT4053 v.6
Modifications:	Legal pages	s updated.	•	
74HC_HCT4053 v.6	20110511	Product data sheet	-	74HC_HCT4053 v.5
74HC_HCT4053 v.5	20110118	Product data sheet	-	74HC_HCT4053 v.4
74HC_HCT4053 v.4	20060509	Product data sheet	-	74HC_HCT4053 v.3
74HC_HCT4053 v.3	20060315	Product data sheet	-	74HC_HCT4053_CNV v.2
74HC_HCT4053_CNV v.2	19901201	Product specification	-	-

### 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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